

Features

- Low intermodulation distortion
 - $IM_3 = -45$ dBc at $P_o = 34.5$ dBm, Single Carrier Level
- High power
 - $P_{1dB} = 45$ dBm at 6.4 GHz to 7.2 GHz
- High efficiency
 - $\eta_{add} = 36\%$ at 6.4 GHz to 7.2 GHz
- High gain
 - $G_{1dB} = 7.0$ dB at 6.4 GHz to 7.2 GHz
- Broadband internally matched
- Hermetically sealed package

RF Performance Specifications ($T_a = 25^\circ\text{C}$)

Characteristic	Symbol	Condition	Unit	Min.	Typ.	Max.
Output Power at 1dB Compression Point	P_{1dB}	$V_{DS} = 10V$ $f = 6.4 \sim 7.2$ GHz	dBm	44.0	45.0	–
Power Gain at 1dB Compression Point	G_{1dB}		dB	6.0	7.0	–
Drain Current	I_{DS}		A	–	7.0	8.0
Power Added Efficiency	η_{add}		%	–	36	–
3rd Order Intermodulation Distortion	IM_3	Note 1	dBc	-42	-45	–
Channel-Temperature Rise	ΔT_{ch}	$V_{DS} \times I_{DS} \times R_{th (c-c)}$	$^\circ\text{C}$	–	–	100

Note 1: 2-tone Test Pout, $P_o = 34.5$ dBm Single Carrier Level.

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristic	Symbol	Condition	Unit	Min.	Typ.	Max.
Transconductance	gm	$V_{DS} = 3V$ $I_{DS} = 10A$	mS	–	6500	–
Pinch-off Voltage	V_{GSoff}	$V_{DS} = 3V$ $I_{DS} = 100$ mA	V	-1.0	-2.5	-4.0
Saturated Drain Current	I_{DSS}	$V_{DS} = 3V$ $V_{GS} = 0V$	A	–	18	22
Gate-Source Breakdown Voltage	V_{GSO}	$I_{GS} = -350$ μA	V	-5	–	–
Thermal Resistance	$R_{th (c-c)}$	Channel to Case	$^\circ\text{C/W}$	–	1.0	1.3

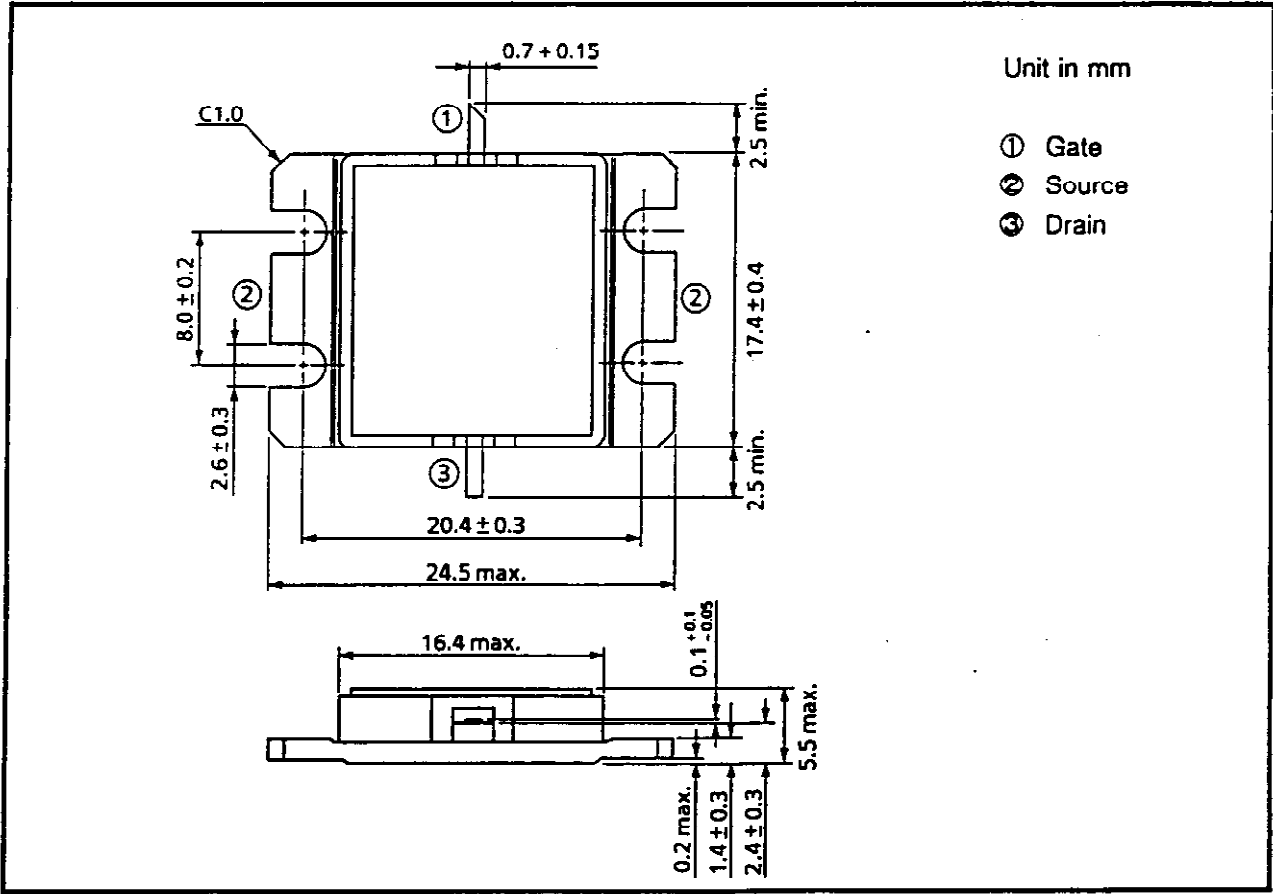
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Absolute Maximum Ratings (T_a = 25°C)

Characteristic	Symbol	Unit	Rating
Drain-Source Voltage	V _{DS}	V	15
Gate-Source Voltage	V _{GS}	V	-5
Drain Current	I _{DS}	A	22
Total Power Dissipation (T _c = 25°C)	P _T	W	115
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65 ~ 175

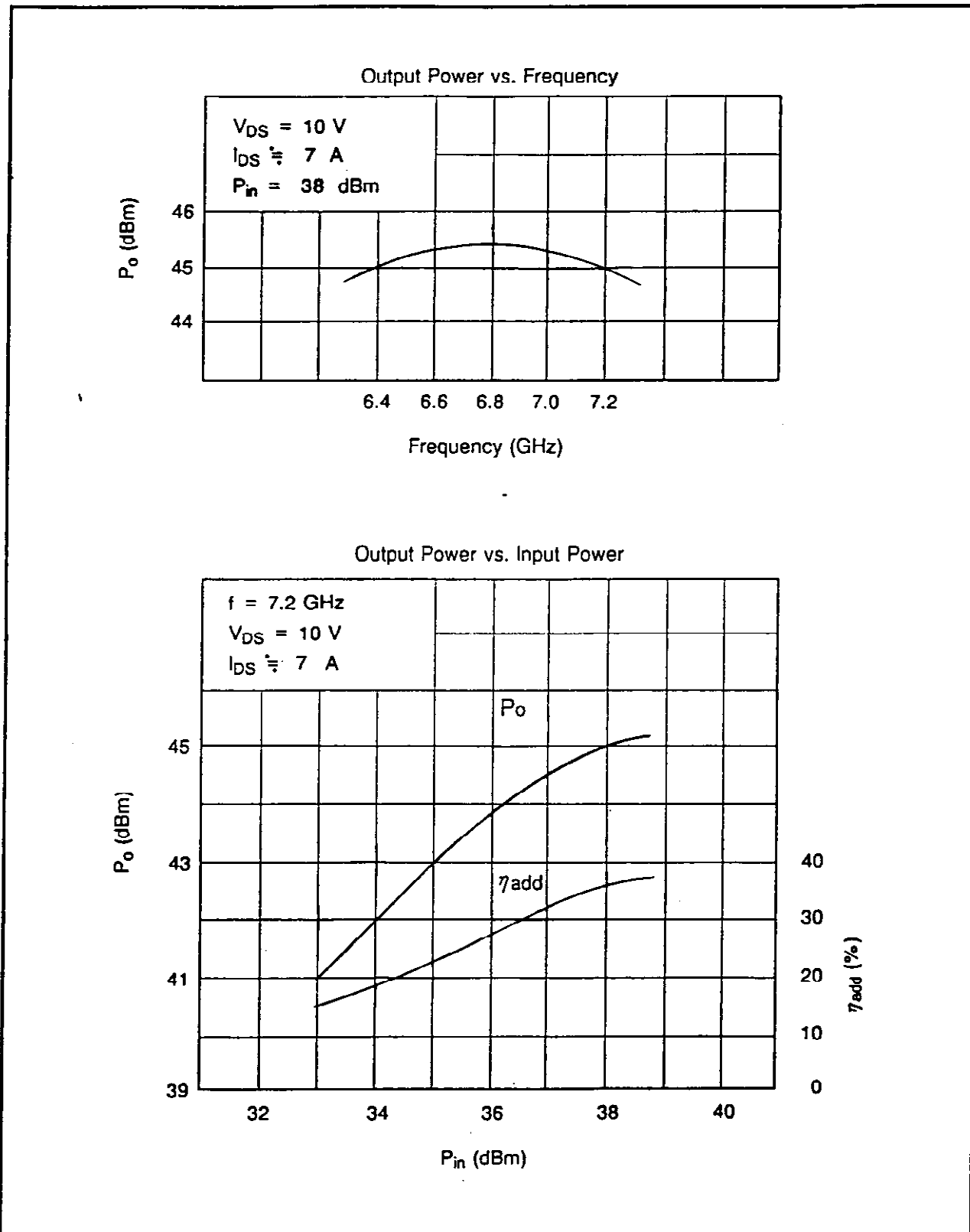
Package Outline (2-16G1B)



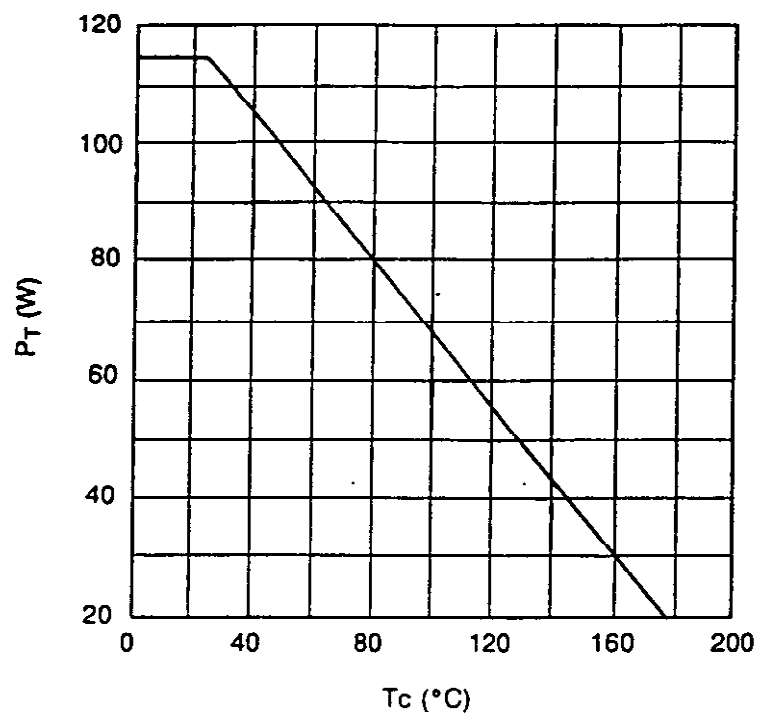
Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

RF Performances



Power Dissipation vs. Case Temperature



IM_3 vs. Output Power Characteristics

